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# FPF1504 / FPF1504L

## Advanced Load Management Switch

### Features

- 1.0 V to 3.6 V Input Voltage Operating Range
- Typical  $R_{DS(ON)}$ :
  - 15 m $\Omega$  at  $V_{IN}=3.3$  V
  - 20 m $\Omega$  at  $V_{IN}=1.8$  V
  - 40 m $\Omega$  at  $V_{IN}=1.0$  V
- Slew Rate Control
- Output Discharge Function
- Low  $<1$   $\mu$ A Quiescent Current at  $V_{ON}=V_{IN}$
- ESD Protected: 4000 V HBM, 2000 V CDM
- GPIO/CMOS-Compatible Enable Circuitry
- Active HIGH and active LOW versions

### Applications

- Mobile Devices and Smart Phones
- Portable Media Devices
- Digital Cameras
- Advanced Notebook, UMPC, and MID
- Portable Medical Devices
- GPS and Navigation Equipment

### Description

The FPF1504/FPF1504L are low- $R_{DS}$  P-channel MOSFET load switches of the IntelliMAX™ family. Integrated slew-rate control prevents excessive inrush current from the supply rails with capacitive loads common in power applications. In addition, the FPF1504/FPF1504L feature output discharge capability.

The input voltage range operates from 1.0 V to 3.6 V to fulfill today's mobile device supply requirements. Switch control is by a logic input (ON pin) capable of interfacing directly with low-voltage CMOS control signals and GPIOs in embedded processors.

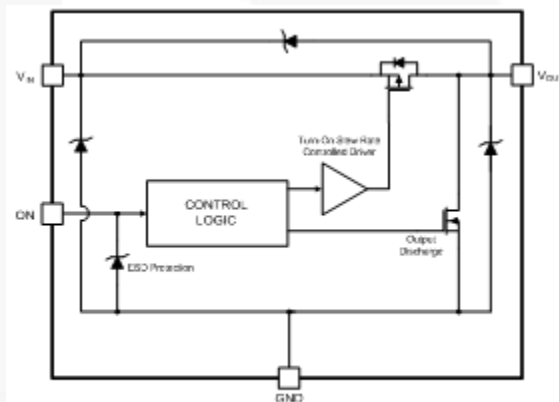


Figure 1. Block Diagram

### Ordering Information

Part Number	Top Mark	Switch (Typical) At 1.8 V <sub>IN</sub>	Input Buffer	Output Discharge	ON Pin Activity	Package
FPF1504UCX	G4	20 m $\Omega$	CMOS	YES	Active HIGH	4-Ball, WLCSP, 0.5 mm Pitch
FPF1504BUCX	G4	20 m $\Omega$	CMOS	YES	Active HIGH	4-Ball, WLCSP with Backside Laminate, 0.5 mm Pitch
FPF1504LUCX	GZ	20 m $\Omega$	CMOS	YES	Active LOW	4-Ball, WLCSP, 0.5 mm Pitch
FPF1504LBUCX	GZ	20 m $\Omega$	CMOS	YES	Active LOW	4-Ball, WLCSP with Backside Laminate, 0.5 mm Pitch

### Application Diagram

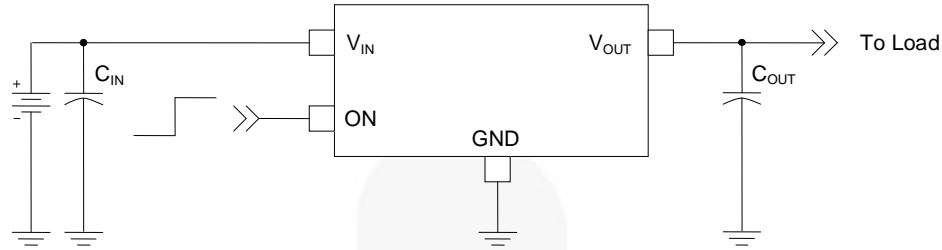


Figure 2. Typical Application

**Notes:**

1.  $C_{IN}=1\ \mu\text{F}$ , X5R, 0603, for example Murata GRM185R60J105KE26.
2.  $C_{OUT}=1\ \mu\text{F}$ , X5R, 0805, for example Murata GRM216R61A105KA01.

### Pin Configurations

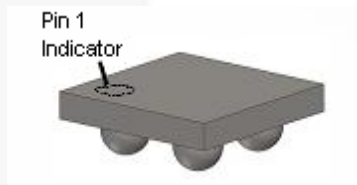


Figure 3. 1 x 1 mm WLCSP Bumps Facing Down

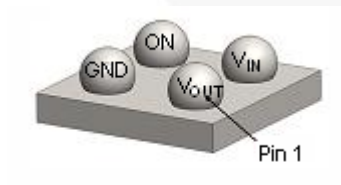


Figure 4. 1 x 1 mm WLCSP Bumps Facing Up

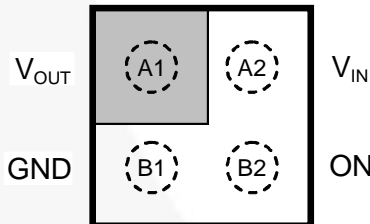


Figure 5. Pin Assignments (Top View)

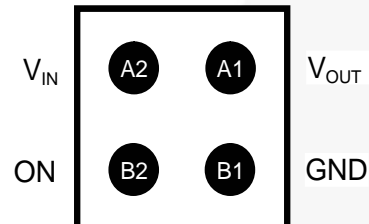


Figure 6. Pin Assignments (Bottom View)

### Pin Definitions

Pin #	Name	Description
A1	$V_{OUT}$	Switch Output
A2	$V_{IN}$	Supply Input; Input to the Power Switch
B1	GND	Ground
B2	ON	ON/OFF Control

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Min.	Max.	Unit
$V_{IN}$	$V_{IN}$ , $V_{OUT}$ , $V_{ON}$ to GND	-0.3	4.0	V
$I_{SW}$	Maximum Continuous Switch Current		1.5	A
$P_D$	Power Dissipation at $T_A=25^\circ\text{C}$		1.0	W
$T_{STG}$	Storage Junction Temperature	-65	+150	$^\circ\text{C}$
$T_A$	Operating Temperature Range	-40	+85	$^\circ\text{C}$
$\Theta_{JA}$	Thermal Resistance, Junction-to-Ambient	1S2P with 1 Thermal Via	95	$^\circ\text{C}/\text{W}$
		1S2P without Thermal Via	187	
ESD	Electrostatic Discharge Capability	Human Body Model, JESD22-A114	4	kV
		Charged Device Model, JESD22-C101	2	

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
$V_{IN}$	Supply Voltage	1.0	3.6	V
$T_A$	Ambient Operating Temperature	-40	+85	$^\circ\text{C}$

## Electrical Characteristics

Unless otherwise noted,  $V_{IN}=1.0$  to  $3.6$  V,  $T_A=-40$  to  $+85^\circ\text{C}$ ; typical values are at  $V_{IN}=3.3$  V and  $T_A=25^\circ\text{C}$ .

Symbol	Parameter		Conditions	Min.	Typ.	Max.	Units
<b>Basic Operation</b>							
$V_{IN}$	Supply Voltage			1.0		3.6	V
$I_{Q(OFF)}$	Off Supply Current	FPF1504	$V_{ON}=\text{GND}, V_{OUT}=\text{Open}$		0.25		$\mu\text{A}$
		FPF1504L	$V_{ON}=V_{IN}, V_{OUT}=\text{Open}$		0.3		
$I_{SD(OFF)}$	Off Switch Current	FPF1504	$V_{ON}=\text{GND}, V_{OUT}=\text{GND}$		0.25		
		FPF1504L	$V_{ON}=V_{IN}, V_{OUT}=\text{GND}$		0.3		
$I_Q$	Quiescent Current	FPF1504	$I_{OUT}=0$ mA, $V_{IN}=3.6$ V, $V_{ON}=V_{IN}$		0.08		
			$I_{OUT}=0$ mA, $V_{ON}=V_{IH(MIN)}$		0.75		
		FPF1504L	$I_{OUT}=0$ mA, $V_{IN}=3.6$ V, $V_{ON}=\text{GND}$		0.08		
			$I_{OUT}=0$ mA, $V_{ON}=V_{IL(MAX)}$		0.95		
$R_{ON}$	On Resistance	$V_{IN}=3.3$ V, $I_{OUT}=200$ mA, $T_A=25^\circ\text{C}$			15	30	m $\Omega$
		$V_{IN}=1.8$ V, $I_{OUT}=200$ mA, $T_A=25^\circ\text{C}$			20	40	
		$V_{IN}=1.5$ V, $I_{OUT}=200$ mA, $T_A=25^\circ\text{C}$			30		
		$V_{IN}=1.0$ V, $I_{OUT}=200$ mA, $T_A=25^\circ\text{C}$			40	80	
		$V_{IN}=1.8$ V, $I_{OUT}=200$ mA, $T_A=85^\circ\text{C}^{(3)}$			35	50	
$R_{PD}$	Output Discharge Pull-Down Resistance		$V_{ON}=0$ V or $V_{IN}$ , $I_{OUT}=-20$ mA		65	95	$\Omega$
$V_{IH}$	On Input Logic High Voltage	FPF1504		0.8			V
$V_{IL}$	On Input Logic Low Voltage	FPF1504			0.3		
$I_{ON}$	On Input Leakage		$V_{ON}=V_{IN}$ or GND			1	$\mu\text{A}$
<b>Dynamic Characteristics</b>							
$t_{DON}$	Turn-On Delay <sup>(4)</sup>	FPF1504	$R_L=10$ $\Omega$ , $C_L=0.1$ $\mu\text{F}$ , $V_{IN}=3.3$ V, $T_A=25^\circ\text{C}$		80		$\mu\text{s}$
$t_R$	$V_{OUT}$ Rise Time <sup>(4)</sup>	FPF1504			130		
$t_{ON}$	Turn-On Time <sup>(4)</sup>	FPF1504			210		
$t_{DON}$	Turn-On Delay <sup>(4)</sup>	FPF1504	$R_L=500$ $\Omega$ , $C_L=0.1$ $\mu\text{F}$ , $V_{IN}=3.3$ V, $T_A=25^\circ\text{C}$		70	100	$\mu\text{s}$
		FPF1504L			95		
$t_R$	$V_{OUT}$ Rise Time <sup>(4)</sup>	FPF1504			110	150	
		FPF1504L			115		
$t_{ON}$	Turn-On Time <sup>(4)</sup>	FPF1504			180	250	
		FPF1504L			210		

Continued on the following page...

## Electrical Characteristics (Continued)

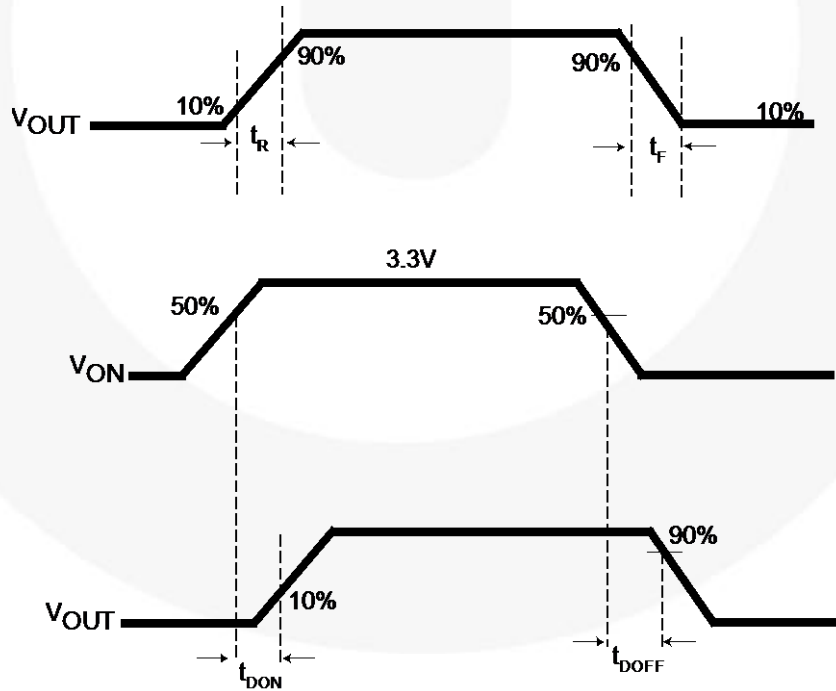
Unless otherwise noted,  $V_{IN}=1.0$  to  $3.6$  V,  $T_A=-40$  to  $+85^\circ\text{C}$ ; typical values are at  $V_{IN}=3.3$  V and  $T_A=25^\circ\text{C}$ .

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
<b>Dynamic Characteristics (Continued)</b>						
$t_{DOFF}$	Turn-Off Delay <sup>(4)</sup>	FPF1504		25	30	$\mu\text{s}$
$t_F$	$V_{OUT}$ Fall Time <sup>(4)</sup>	FPF1504	$R_L=10\ \Omega$ , $C_L=0.1\ \mu\text{F}$ , $V_{IN}=3.3\ \text{V}$ , $T_A=25^\circ\text{C}$	2		
$t_{OFF}$	Turn-Off Time <sup>(4)</sup>	FPF1504		27		
$t_{DOFF}$	Turn-Off Delay <sup>(4)</sup>	FPF1504 FPF1504L			25 2	
$t_F$	$V_{OUT}$ Fall Time <sup>(4)</sup>	FPF1504 FPF1504L	$R_L=500\ \Omega$ , $C_L=0.1\ \mu\text{F}$ , $V_{IN}=3.3\ \text{V}$ , $T_A=25^\circ\text{C}$	12 14		
$t_{OFF}$	Turn-Off Time <sup>(4)</sup>	FPF1504 FPF1504L		37 16		

**Notes:**

3. This parameter is guaranteed by design and characterization; not production tested.
4.  $t_{DON}/t_{DOFF}/t_R/t_F$  are defined in Figure 7.
5. Output discharge path is enabled during off.

### Timing Diagram – FPF1504



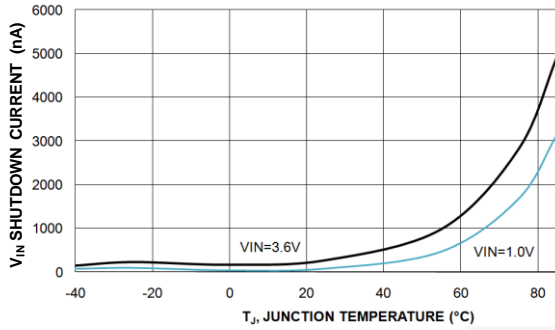
**Notes:**

6.  $t_{ON}=t_R + t_{DON}$ .
7.  $t_{OFF}=t_F + t_{DOFF}$ .

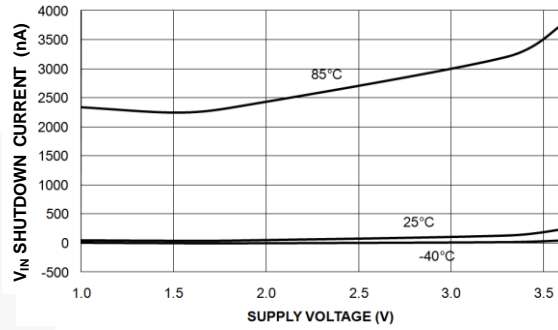
Figure 7. Timing Diagram for FPF1504

## Typical Performance Characteristics for FPF1504

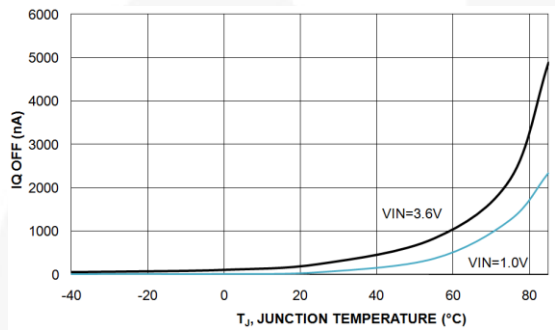
Applicable to active high version only.



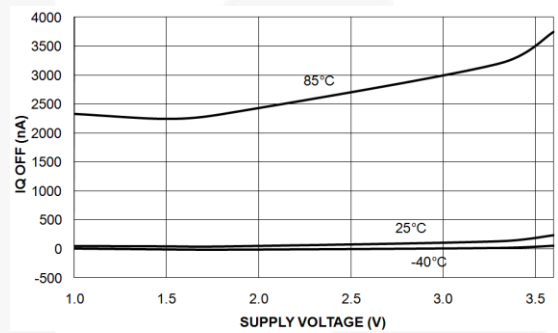
**Figure 8. Shutdown Current vs. Temperature**



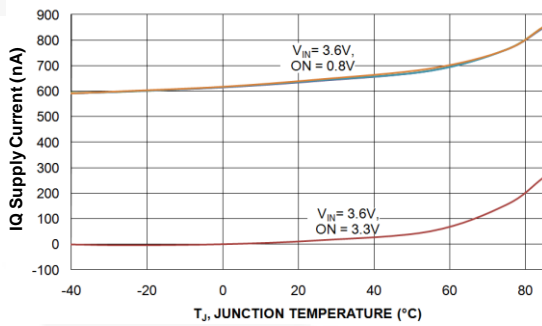
**Figure 9. Shutdown Current vs. Supply Voltage**



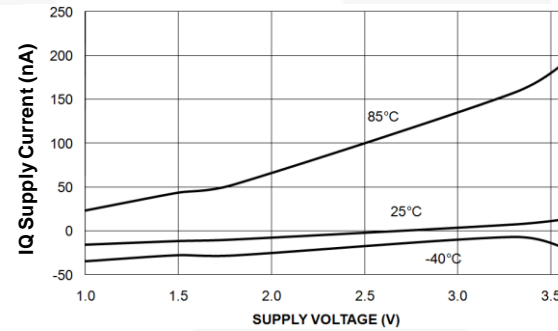
**Figure 10. Off Supply Current vs. Temperature**



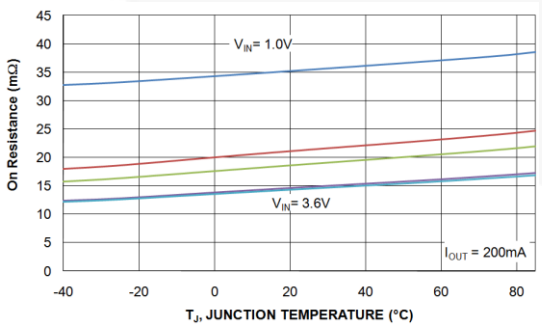
**Figure 11. Off Supply Current vs. Supply Voltage**



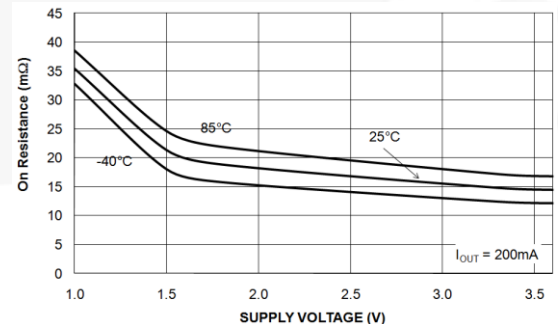
**Figure 12. Quiescent Current vs. Temperature**



**Figure 13. Quiescent Current vs. Supply Voltage (V<sub>ON</sub>=V<sub>IN</sub>)**



**Figure 14. R<sub>ON</sub> vs. Temperature**



**Figure 15. R<sub>ON</sub> vs. Supply Voltage**

## Typical Performance Characteristics for FPF1504

Applicable to active high version only.

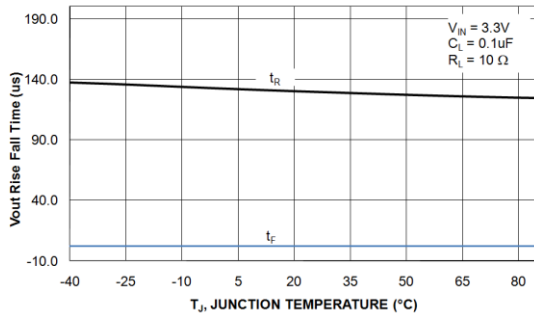


Figure 16.  $V_{OUT}$  Rise/Fall Times vs. Temperature ( $R_L=10\ \Omega$ )

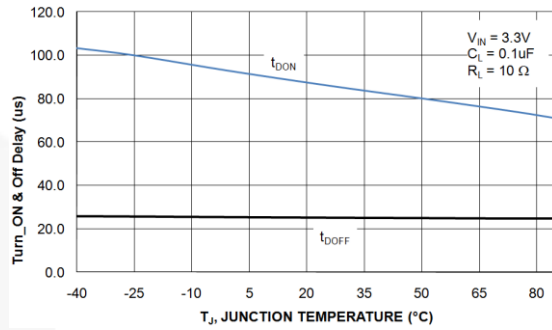


Figure 17.  $V_{OUT}$  Turn-On/Turn-Off Delays vs. Temperature ( $R_L=10\ \Omega$ )

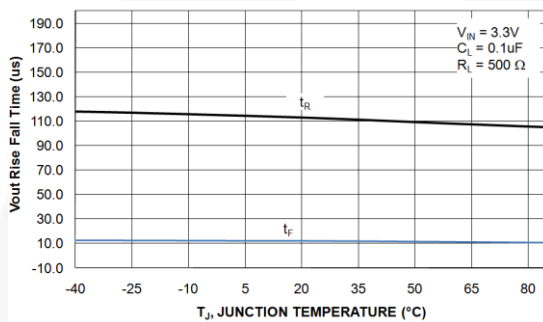


Figure 18.  $V_{OUT}$  Rise/Fall Time vs. Temperature ( $R_L=500\ \Omega$ )

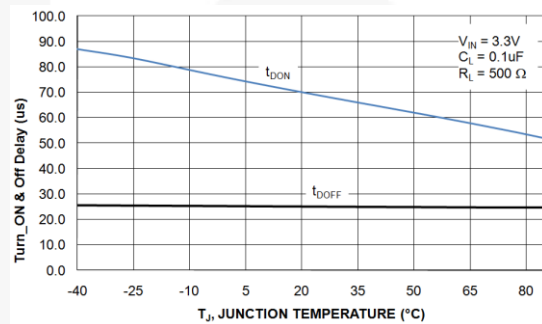


Figure 19.  $V_{OUT}$  Turn-On/Turn-Off Delays vs. Temperature ( $R_L=500\ \Omega$ )

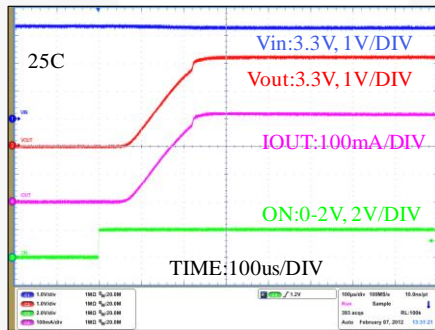


Figure 20. Turn-On Response ( $V_{IN}=3.3\ \text{V}$ ,  $C_{OUT}=0.1\ \mu\text{F}$ ,  $R_L=10\ \Omega$ )

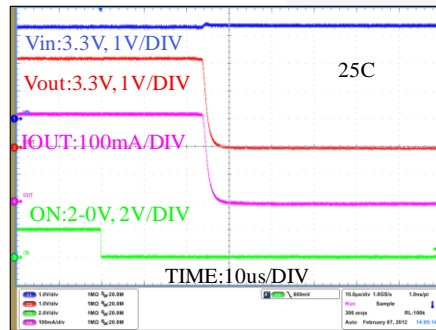


Figure 21. Turn-Off Response ( $V_{IN}=3.3\ \text{V}$ ,  $C_{OUT}=0.1\ \mu\text{F}$ ,  $R_L=10\ \Omega$ )

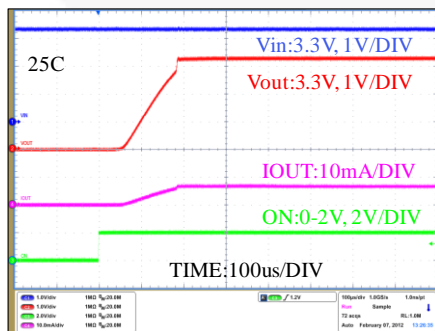


Figure 22. Turn-On Response ( $V_{IN}=3.3\ \text{V}$ ,  $C_{OUT}=0.1\ \mu\text{F}$ ,  $R_L=500\ \Omega$ )

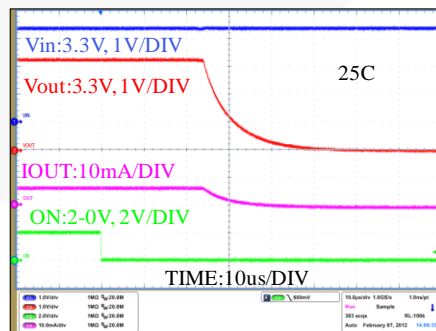


Figure 23. Turn-Off Response ( $V_{IN}=3.3\ \text{V}$ ,  $C_{OUT}=0.1\ \mu\text{F}$ ,  $R_L=500\ \Omega$ )



## Application Information

### Input Capacitor

IntelliMAX™ switches don't require an input capacitor. To reduce device inrush current, a 0.1 μF ceramic capacitor, C<sub>IN</sub>, is recommended close to the VIN pin. A higher value of C<sub>IN</sub> can be used to further reduce the voltage drop experienced as the switch is turned on into a large capacitive load.

### Output Capacitor

IntelliMAX™ switches work without an output capacitor. If the applications parasitic board inductance forces V<sub>OUT</sub> below GND when switching off, a 0.1 μF capacitor, C<sub>OUT</sub>, should be placed between V<sub>OUT</sub> and GND.

### Fall Time

Device output fall time can be calculated based on RC constant of external components as follows:

$$t_F = R_L \times C_L \times 2.2 \quad (1)$$

where t<sub>F</sub> is 90% to 10% fall time, R<sub>L</sub> is output load, load and C<sub>L</sub> is output capacitor.

The same equation works for a device with a pull-down output resistor, then R<sub>L</sub> is replaced by a parallel connected pull-down and external output resistor combination, as follows:

$$t_F = \frac{R_L \times R_{PD}}{R_L + R_{PD}} \times C_L \times 2.2 \quad (2)$$

where t<sub>F</sub> is 90% to 10% fall time, R<sub>L</sub> is output load, R<sub>PD</sub> is output pull-down resistor (65 Ω typical), and C<sub>L</sub> is the output capacitor.

## Recommended Land Pattern and Layout

For best thermal performance and minimal inductance and parasitic effects, it is recommended to keep input and output traces short and the capacitors as close to

the device as possible. Below is a recommended layout for this device to achieve optimum performance.

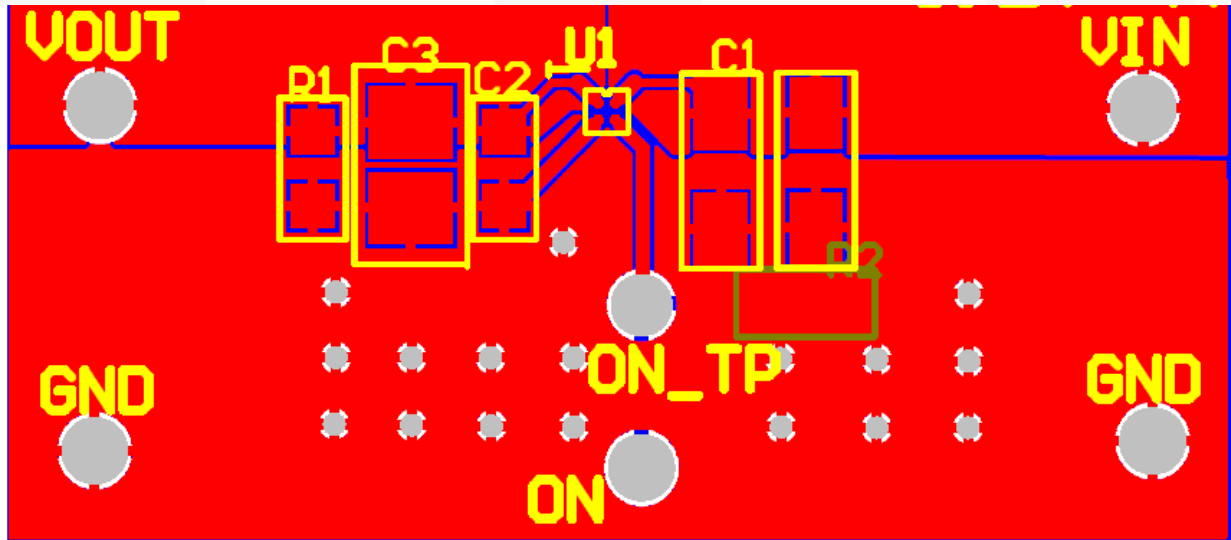


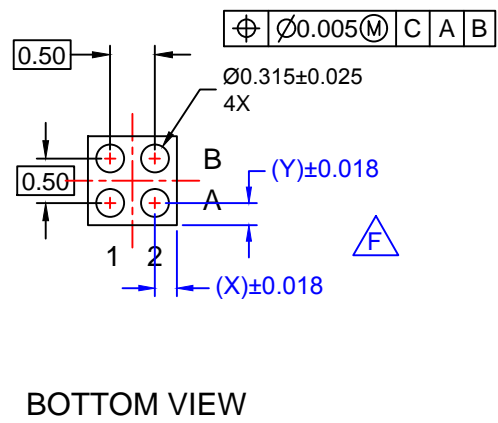
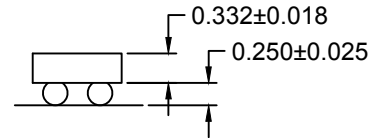
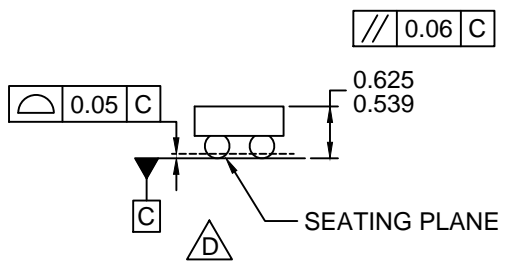
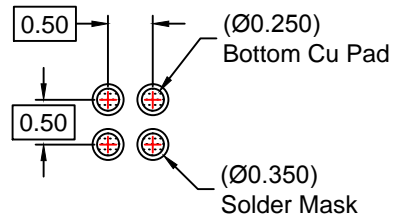
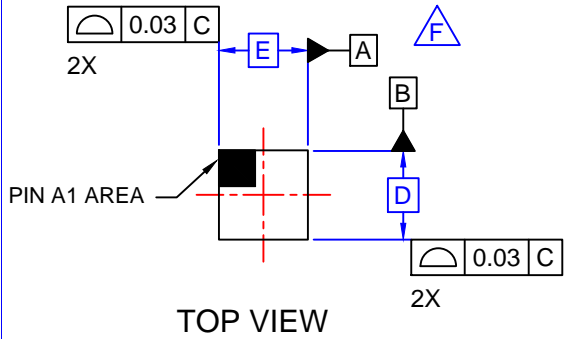
Figure 24. Recommended Land Pattern and Layout

The following information applies to the WLCSP package dimensions on the next page:

**Product-Specific Dimensions**

Product	D	E	X	Y
FPF1504UCX	960 $\mu\text{m}$ $\pm$ 30 $\mu\text{m}$	960 $\mu\text{m}$ $\pm$ 30 $\mu\text{m}$	0.230 mm	0.230 mm
FPF1504BUCX				
FPF1504LUCX				
FPF1504LBUCX				





- NOTES:
- A. NO JEDEC REGISTRATION APPLIES.
  - B. DIMENSIONS ARE IN MILLIMETERS.
  - C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
  - D. DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
  - E. PACKAGE NOMINAL HEIGHT IS 582 MICRONS ±43 MICRONS (539-625 MICRONS).
  - F. FOR DIMENSIONS D, E, X, AND Y SEE PRODUCT DATASHEET.
  - G. DRAWING FILENAME: MKT-UC004ABrev3.



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Наши преимущества:

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- Подбор оптимального решения, техническое обоснование при выборе компонента;
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- Техническая поддержка проекта;
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#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.